

Silicon Epicap Diode

Designed for general frequency control and tuning applications; providing solid–state reliability in replacement of mechnaical tuning methods.

• High Q with Guaranteed Minimum Values at VHF Frequencies

ORDERING INFORMATION

Package

SOD-323

- Controlled and Uniform Tuning Ratio
- Surface Mount Package

Device

MMVL109T1

• Device Marking: 4A





MAXIMUM RATINGS

Symbol	Rating	Value	Unit	
V _R	Continuous Reverse Voltage	30	Vdc	
I _F	Peak Forward Current	200	mAdc	

Shipping

3000 / Tape & Reel

THERMALCHARACTERISTICS

Symbol	Characteristic	Max	Unit
PD	Total Device Dissipation FR-5 Board,*	200	mW
	$T_A = 25^{\circ}C$		
	Derate above 25°C	1.57	mW/°C
R _{θJA}	Thermal Resistance Junction to Ambient	635	°C/W
T_{J},T_{stg}	Junction and Storage Temperature Range	-55 to +150	C

*FR-5 Minimum Pad

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse BreakdownVoltage	V _{(BR)R}	30	_	_	Vdc
$(I_R = 10 \ \mu Adc)$					
Reverse Voltage Leakage Current	I _R	—	—	0.1	μAdc
$(V_R = 25 \text{ Vdc})$					
Diode Capacitance Temperature Coefficient	TCc	_	300	_	ppm/°C
$(V_R = 3.0 \text{ Vdc}, f = 1.0 \text{ MHz})$					

	C _t , Diode Capacitance V _R = 3.0 Vdc, f = 1.0 MHz pF		Q, Figure of Merit $V_R = 3.0 Vdc$	C _R , Capaci C ₃	itance Ratio /C ₂₅	
			f = 50 MHz	f = 1.0 MHz(Note 1)		
Device	Min	Nom	Max	Min	Min	Max
MMVL109T1	26	29	32	200	5.0	6.5

1. C_{R} is the ratio of C_t measured at 3 Vdc divided by C_t measured at 25 Vdc.



MMVL109T1



TYPICAL CHARACTERISTICS



1. C_R is the ratio of C_t measured at 3.0 Vdc divided by C_t measured at 25 Vdc.